

## 18A, 500V N-CHANNEL MOSFET

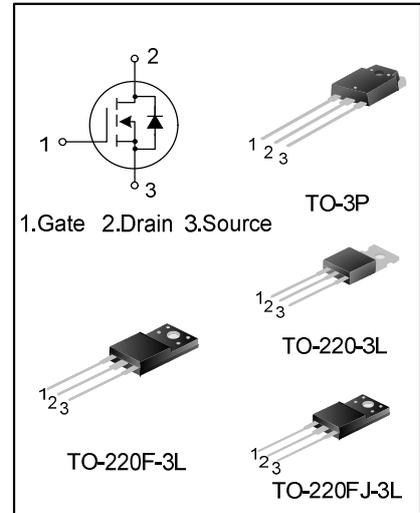
### GENERAL DESCRIPTION

SVF18N50F/T/PN/FJ is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ high-voltage planar VDMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

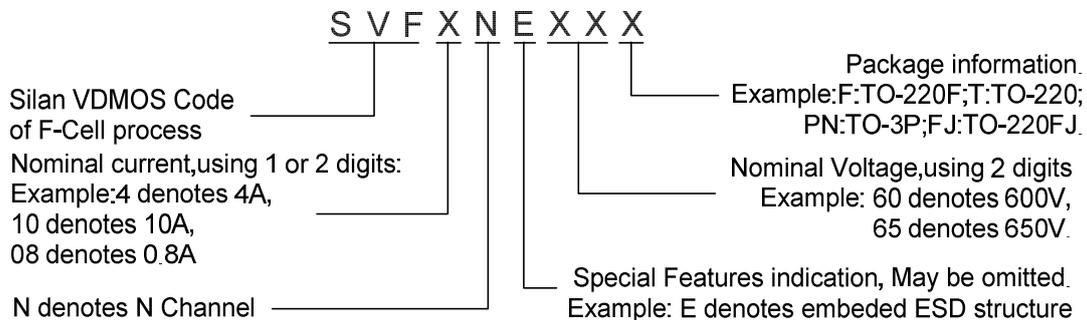
These devices are widely used in AC-DC power supplies, DC-DC converters and H-bridge PWM motor drivers.

### FEATURES

- ◆ 18A,500V, $R_{DS(on)(typ.)}=0.26\Omega@V_{GS}=10V$
- ◆ Low gate charge
- ◆ Low Crss
- ◆ Fast switching
- ◆ Improved dv/dt capability



### NOMENCLATURE



### ORDERING INFORMATION

| Part No.   | Package     | Marking    | Hazardous Substance Control | Packing |
|------------|-------------|------------|-----------------------------|---------|
| SVF18N50F  | TO-220F-3L  | SVF18N50F  | Pb free                     | Tube    |
| SVF18N50T  | TO-220-3L   | SVF18N50T  | Pb free                     | Tube    |
| SVF18N50PN | TO-3P       | 18N50      | Pb free                     | Tube    |
| SVF18N50FJ | TO-220FJ-3L | SVF18N50FJ | Halogen free                | Tube    |

**ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C unless otherwise noted)**

| Characteristics   | Symbol           | Ratings                |           |            | Unit |
|---|------------------|------------------------|-----------|------------|------|
|   |                  | SVF18N50F/FJ           | SVF18N50T | SVF18N50PN |      |
| Drain-Source Voltage  | V <sub>DS</sub>  | 500                    |           |            | V    |
| Gate-Source Voltage   | V <sub>GS</sub>  | ±30                    |           |            | V    |
| Drain Current   | I <sub>D</sub>   | T <sub>C</sub> = 25°C  |           |            | A    |
|   |                  | T <sub>C</sub> = 100°C |           |            |      |
| Drain Current Pulsed  | I <sub>DM</sub>  | 72.0                   |           |            | A    |
| Power Dissipation(T <sub>C</sub> =25°C)<br>-Derate above 25°C | P <sub>D</sub>   | 54                     | 232       | 240        | W    |
|   |                  | 0.43                   | 1.86      | 1.92       | W/°C |
| Single Pulsed Avalanche Energy (Note 1)                       | E <sub>AS</sub>  | 1502                   |           |            | mJ   |
| Operation Junction Temperature Range                          | T <sub>J</sub>   | -55~+150               |           |            | °C   |
| Storage Temperature Range                                     | T <sub>stg</sub> | -55~+150               |           |            | °C   |

**THERMAL CHARACTERISTICS**

| Characteristics                         | Symbol           | Ratings      |           |            | Unit |
|---|------------------|--------------|-----------|------------|------|
|   |                  | SVF18N50F/FJ | SVF18N50T | SVF18N50PN |      |
| Thermal Resistance, Junction-to-Case    | R <sub>θJC</sub> | 2.31         | 0.54      | 0.52       | °C/W |
| Thermal Resistance, Junction-to-Ambient | R <sub>θJA</sub> | 62.5         | 62.5      | 50         | °C/W |

**ELECTRICAL CHARACTERISTICS (T<sub>C</sub>=25°C unless otherwise noted)**

| Characteristics                             | Symbol              | Test conditions   | Min. | Typ. | Max. | Unit |
|---|---------------------|---|------|------|------|------|
| Drain -Source Breakdown Voltage             | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA  | 500  | --   | --   | V    |
| Drain-Source Leakage Current                | I <sub>DSS</sub>    | V <sub>DS</sub> =500V, V <sub>GS</sub> =0V  | --   | --   | 1.0  | μA   |
| Gate-Source Leakage Current                 | I <sub>GSS</sub>    | V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V  | --   | --   | ±100 | nA   |
| Gate Threshold Voltage                      | V <sub>GS(th)</sub> | V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> =250μA                               | 2.0  | --   | 4.0  | V    |
| Static Drain- Source<br>On State Resistance | R <sub>DS(on)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =9.0A  | --   | 0.26 | 0.31 | Ω    |
| Input Capacitance                           | C <sub>ISS</sub>    | V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHZ                                     | --   | 2320 | --   | pF   |
| Output Capacitance                          | C <sub>OSS</sub>    |   | --   | 282  | --   |      |
| Reverse Transfer Capacitance                | C <sub>RSS</sub>    |   | --   | 7    | --   |      |
| Turn-on Delay Time                          | t <sub>d(on)</sub>  | V <sub>DD</sub> =250V, I <sub>D</sub> =18.0A,<br>R <sub>G</sub> =25Ω<br><br>(Note 2,3)  | --   | 60   | --   | ns   |
| Turn-on Rise Time                           | t <sub>r</sub>      |   | --   | 131  | --   |      |
| Turn-off Delay Time                         | t <sub>d(off)</sub> |   | --   | 115  | --   |      |
| Turn-off Fall Time                          | t <sub>f</sub>      |   | --   | 75   | --   |      |
| Total Gate Charge                           | Q <sub>g</sub>      | V <sub>DS</sub> =400V, I <sub>D</sub> =18.0A,<br>V <sub>GS</sub> =10V<br><br>(Note 2,3) | --   | 38   | --   | nC   |
| Gate-Source Charge                          | Q <sub>gs</sub>     |   | --   | 12   | --   |      |
| Gate-Drain Charge                           | Q <sub>gd</sub>     |   | --   | 12   | --   |      |

## SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

| Characteristics           | Symbol   | Test conditions  | Min. | Typ. | Max. | Unit    |
|---------------------------|----------|--|------|------|------|---------|
| Continuous Source Current | $I_S$    | Integral Reverse p-n Junction Diode in the MOSFET        | --   | --   | 18.0 | A       |
| Pulsed Source Current     | $I_{SM}$ |  | --   | --   | 72.0 |         |
| Diode Forward Voltage     | $V_{SD}$ | $I_S=18.0A, V_{GS}=0V$                                   | --   | --   | 1.3  | V       |
| Reverse Recovery Time     | $T_{rr}$ | $I_S=18.0A, V_{GS}=0V,$<br>$di_F/dt=100A/\mu s$ (Note 2) | --   | 583  | --   | ns      |
| Reverse Recovery Charge   | $Q_{rr}$ |  | --   | 7.1  | --   | $\mu C$ |

### Notes:

1.  $L=30mH, I_{AS}=8.60A, V_{DD}=140V, R_G=25\Omega$ , starting  $T_J=25^\circ C$ ;
2. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ ;
3. Essentially independent of operating temperature.

**TYPICAL CHARACTERISTICS**

Figure 1. On-Region Characteristics

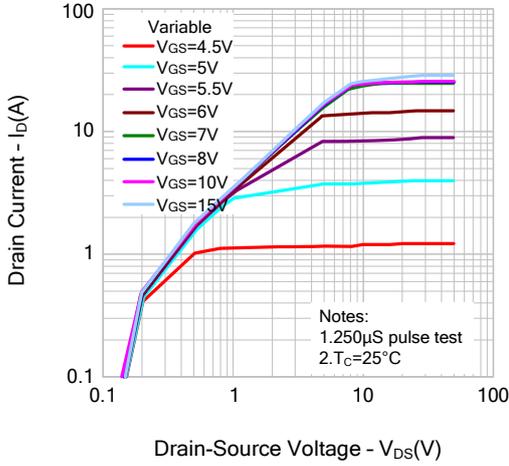


Figure 2. Transfer Characteristics

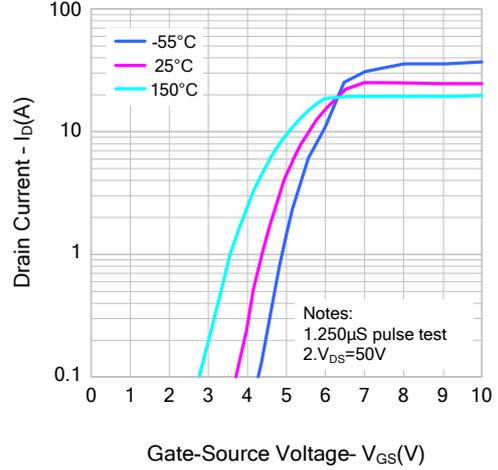


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

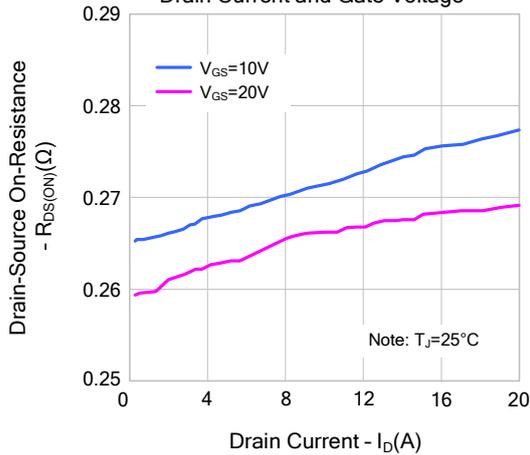


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

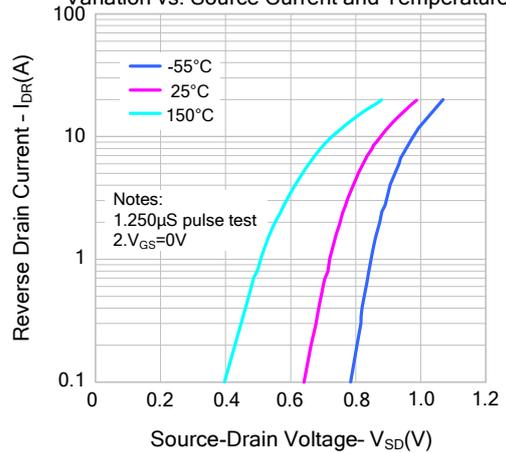


Figure 5. Capacitance Characteristics

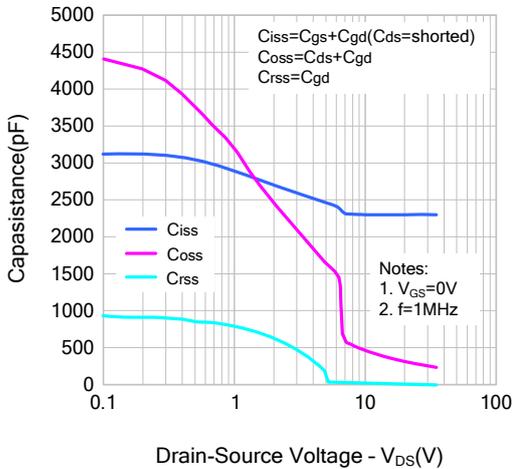
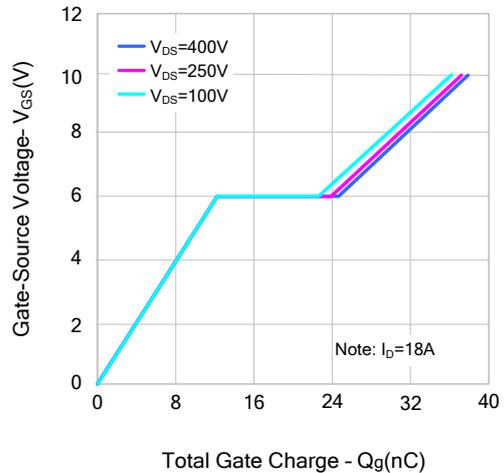


Figure 6. Gate Charge Characteristics



**TYPICAL CHARACTERISTICS (continued)**

Figure 7. Breakdown Voltage Variation vs. Temperature

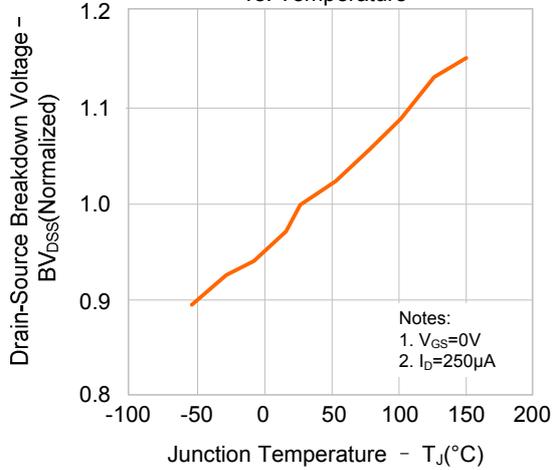


Figure 8. On-resistance Variation vs. Temperature

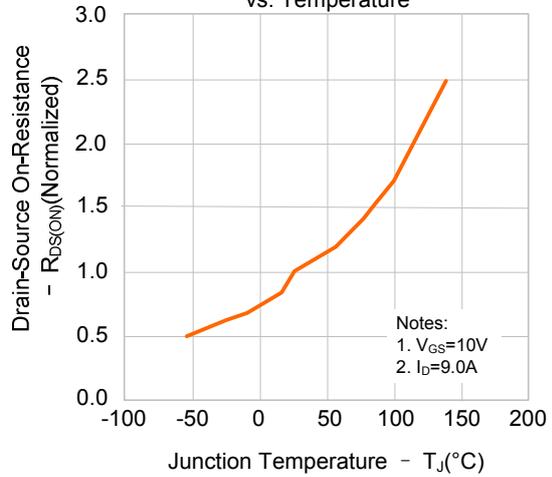


Figure 9-1. Max. Safe Operating Area(SVF18N50F/FJ)

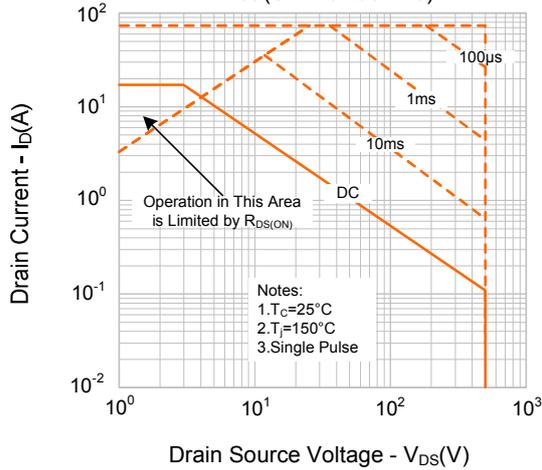


Figure 9-2. Max. Safe Operating Area(SVF18N50T)

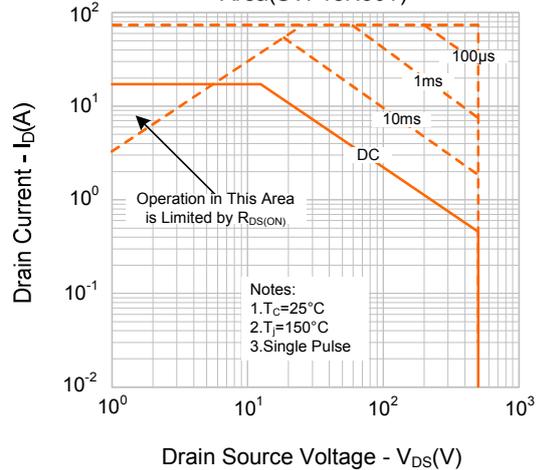


Figure 9-3. Max. Safe Operating Area(SVF18N50PN)

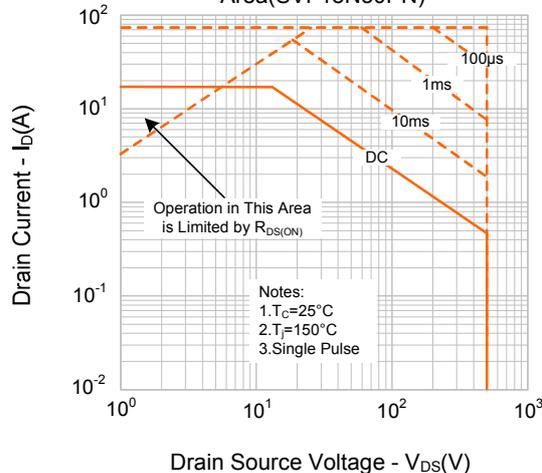
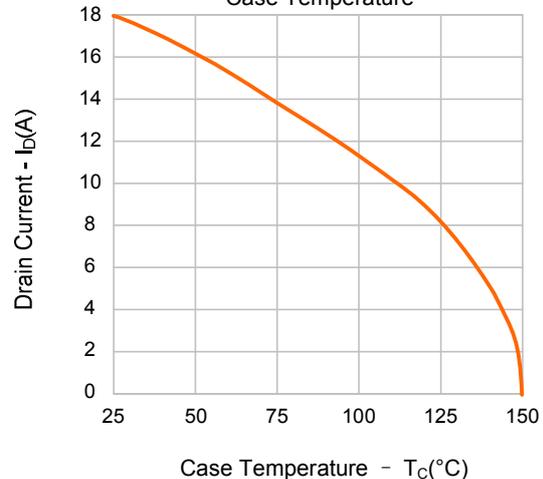
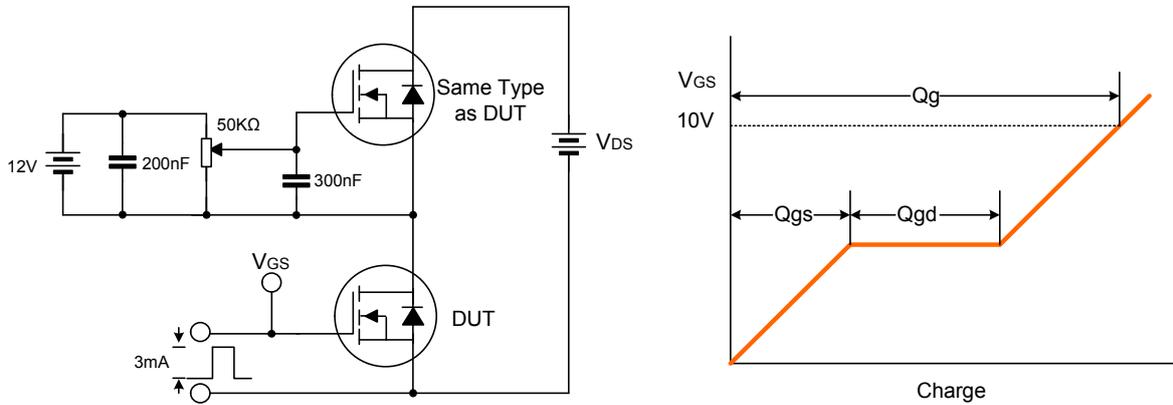


Figure 10. Maximum Drain Current vs. Case Temperature

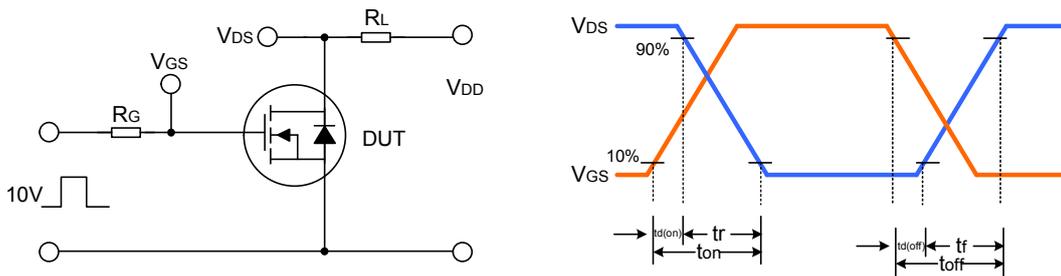


**TYPICAL TEST CIRCUIT**

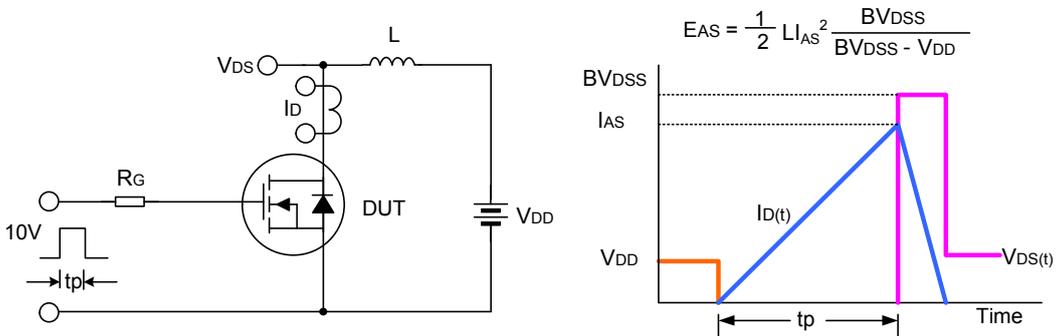
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



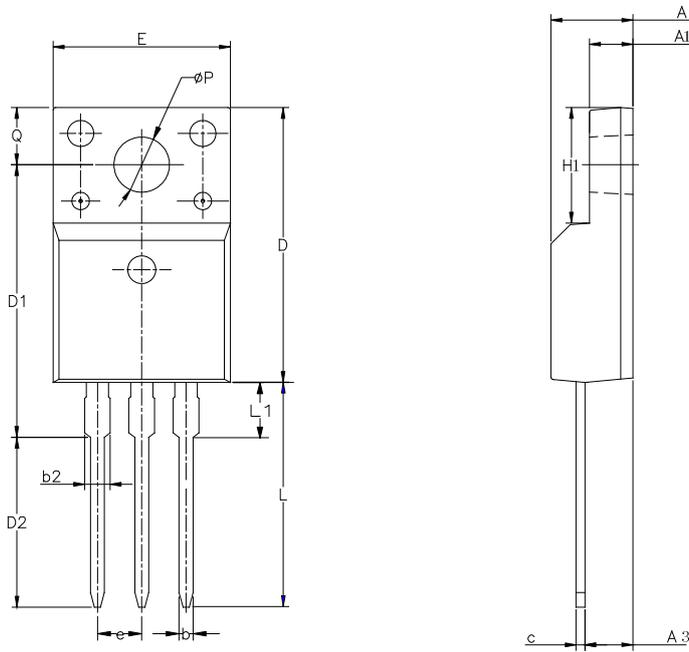
Unclamped Inductive Switching Test Circuit & Waveform



**PACKAGE OUTLINE**

**TO-220F-3L**

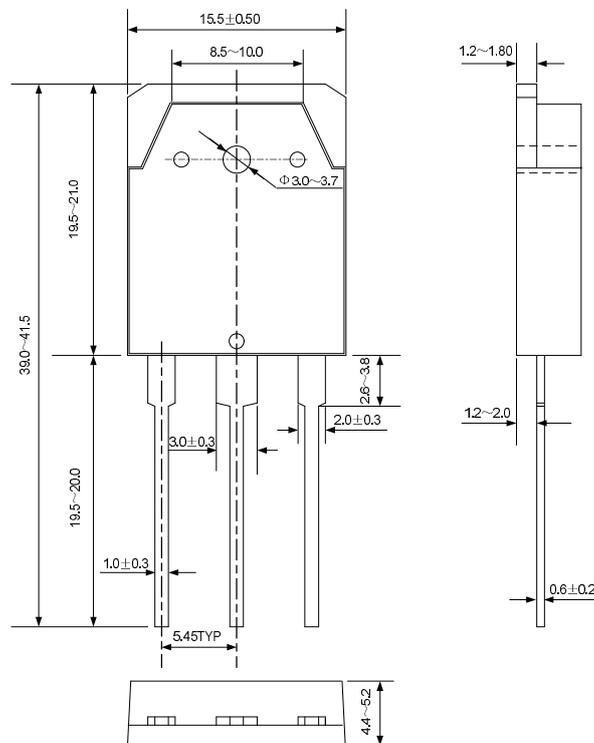
**UNIT: mm**



| SYMBOL   | MIN     | NOM   | MAX   |
|----------|---------|-------|-------|
| A        | 4.42    | 4.70  | 5.02  |
| A1       | 2.30    | 2.54  | 2.80  |
| A3       | 2.50    | 2.76  | 3.10  |
| b        | 0.70    | 0.80  | 0.90  |
| b2       | —       | —     | 1.47  |
| c        | 0.35    | 0.50  | 0.65  |
| D        | 15.25   | 15.87 | 16.25 |
| D1       | 15.30   | 15.75 | 16.30 |
| D2       | 9.30    | 9.80  | 10.30 |
| E        | 9.73    | 10.16 | 10.36 |
| e        | 2.54BCS |       |       |
| H1       | 6.40    | 6.68  | 7.00  |
| L        | 12.48   | 12.98 | 13.48 |
| L1       | /       | /     | 3.50  |
| $\phi P$ | 3.00    | 3.18  | 3.40  |
| Q        | 3.05    | 3.30  | 3.55  |

**TO-3P**

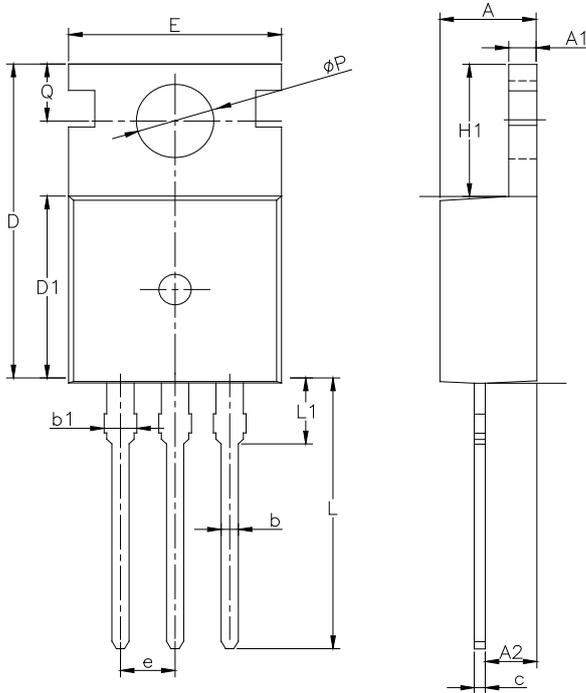
**UNIT: mm**



**PACKAGE OUTLINE(continued)**

**TO-220-3L**

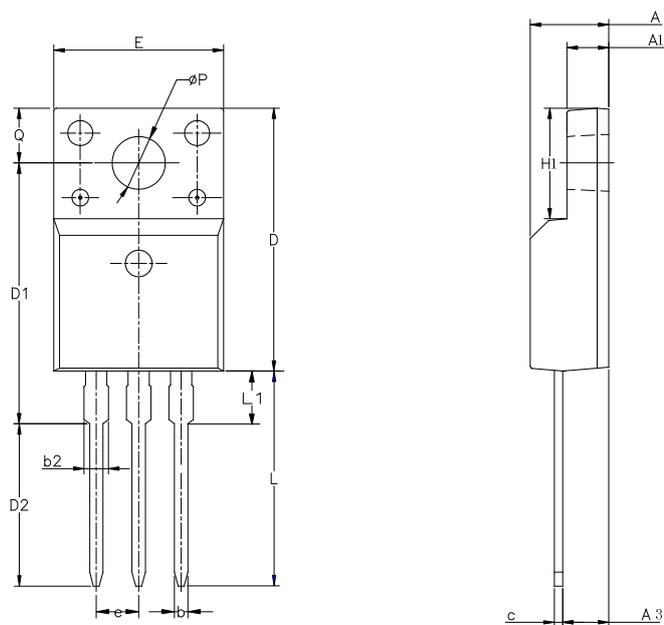
**UNIT: mm**



| SYMBOL   | MIN     | NOM   | MAX   |
|----------|---------|-------|-------|
| A        | 4.30    | 4.50  | 4.70  |
| A1       | 1.00    | 1.30  | 1.50  |
| A2       | 1.80    | 2.40  | 2.80  |
| b        | 0.60    | 0.80  | 1.00  |
| b1       | 1.00    | —     | 1.60  |
| c        | 0.30    | —     | 0.70  |
| D        | 15.10   | 15.70 | 16.10 |
| D1       | 8.10    | 9.20  | 10.00 |
| E        | 9.60    | 9.90  | 10.40 |
| e        | 2.54BSC |       |       |
| H1       | 6.10    | 6.50  | 7.00  |
| L        | 12.60   | 13.08 | 13.60 |
| L1       | —       | —     | 3.95  |
| $\phi P$ | 3.40    | 3.70  | 3.90  |
| Q        | 2.60    | —     | 3.20  |

**TO-220FJ-3L**

**UNIT: mm**



| SYMBOL   | MIN     | NOM   | MAX   |
|----------|---------|-------|-------|
| A        | 4.42    | 4.70  | 5.02  |
| A1       | 2.30    | 2.54  | 2.80  |
| A3       | 2.50    | 2.76  | 3.10  |
| b        | 0.55    | 0.70  | 0.85  |
| b2       | —       | —     | 1.29  |
| c        | 0.35    | 0.50  | 0.65  |
| D        | 15.25   | 15.87 | 16.25 |
| D1       | 13.97   | 14.47 | 14.97 |
| D2       | 10.58   | 11.08 | 11.58 |
| E        | 9.73    | 10.16 | 10.36 |
| e        | 2.54BCS |       |       |
| H1       | 6.40    | 6.68  | 7.00  |
| L        | 12.48   | 12.98 | 13.48 |
| L1       | —       | —     | 2.00  |
| $\phi P$ | 3.00    | 3.18  | 3.40  |
| Q        | 3.05    | 3.30  | 3.55  |

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|            |   |                |   |
|------------|---|----------------|---|
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Rev.: 2.1

## Revision History:

1. Add the package information of TO-220FJ-3L
  2. Update characteristics
- 

Rev.: 2.0

## Revision History:

1. Modify the package information of TO-220-3L
- 

Rev.: 1.9

## Revision History:

1. Modify the package information of TO-220F-3L
- 

Rev.: 1.8

## Revision History:

1. Modify the thermal characteristics
- 

Rev.: 1.7

## Revision History:

1. Modify the ordering information
- 

Rev.: 1.6

## Revision History:

1. Change the schematic diagram of MOS
- 

Rev.: 1.5

## Revision History:

1. Modify "TYPICAL CHARACTERISTICS"
- 

Rev.: 1.4

## Revision History:

1. Modify the values of  $T_{rr}$  and  $Q_{rr}$
- 

Rev.: 1.3

## Revision History:

1. Modify "TYPICAL CHARACTERISTICS"
- 

Rev.: 1.2

## Revision History:

1. Add the package of TO-220-3L
-

Rev.: 1.1

Revision History:

1. Modify "PACKAGE OUTLINE"
- 

Rev.: 1.0

Revision History:

1. Original
- 
-